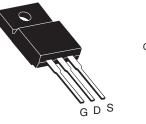
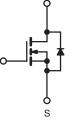
Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	200				
R _{DS(on)} (Ω)	$V_{GS} = 5.0 V$	0.18			
Q _g (Max.) (nC)	66				
Q _{gs} (nC)	9.0				
Q _{gd} (nC)	38				
Configuration	Single				

TO-220 FULLPAK





N-Channel MOSFET

FEATURES

- Isolated Package
- High Voltage Isolation = 2.5 kV_{RMS} (t = 60 s; f = 60 Hz)
- Sink to Lead Creepage Dist. 4.8 mm
- · Logic-Level Gate Drive
- R_{DS(on)} Specified at V_{GS} = 4V and 5 V
- · Fast Switching
- · Ease of paralleling
- Lead (Pb)-free Available

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 FULLPAK eliminates the need for additional insulating hardware in commercial-industrial applications. The molding compound used provides a high isolation capability and a low thermal resistance between the tab and external heatsink. This isolation is equivalent to using a 100 micron mica barrier with standard TO-220 product. The FULLPAK is mounted to a heatsink using a single clip or by a single screw fixing.

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free	IRLI640GPbF
	SiHLI640G-E3
SnPb	IRLI640G
	SiHLI640G

ABSOLUTE MAXIMUM RATINGS	_C = 25 °C, u	nless otherw			1	
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	200	- V	
Gate-Source Voltage			V _{GS}	± 10		
Continuous Drain Current	V _{GS} at 5.0 V	$T_C = 25 \degree C$ $T_C = 100 \degree C$	I _D	9.9		
	VGS at 5.0 V	$T_{C} = 100 ^{\circ}C$	טי	6.3	А	
Pulsed Drain Current ^a			I _{DM}	40		
Linear Derating Factor				0.32	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	290	mJ	
Repetitive Avalanche Current ^a		I _{AR}	9.9	A		
Repetitive Avalanche Energy ^a			E _{AR}	4.0	mJ	
Maximum Power Dissipation	T _C = 25 °C		PD	40	W	
Peak Diode Recovery dV/dt ^c			dV/dt	5.0	V/ns	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 150	°C		
Soldering Recommendations (Peak Temperature)	for 10 s			300 ^d	1 ~	
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in	
			F	1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

- b. $V_{DD} = 25 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 4.4 mH, $R_G = 25 \Omega$, $I_{AS} = 9.9 \text{ A}$ (see fig. 12). c. $I_{SD} \le 17 \text{ A}$, dl/dt $\le 150 \text{ A/}\mu$ s, $V_{DD} \le V_{DS}$, $T_J \le 150 \text{ °C}$.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply



RoHS COMPLIANT

IRLI640G, SiHLI640G

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THERMAL RESISTANCE RAT	rings					-		
PARAMETER	SYMBOL	TYP. MAX.			UNIT			
Maximum Junction-to-Ambient	R _{thJA}	- 65			*CAN			
Maximum Junction-to-Case (Drain)	R _{thJC}	- 3.1				°C/W		
SPECIFICATIONS $T_J = 25 \ ^{\circ}C$,	unless otherv	vise noted						
PARAMETER	SYMBOL	TES	T CONDITI	ONS	MIN.	TYP.	MAX.	UNI
Static					•	•		
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	50 µA	200	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	I _D = 1 mA	-	0.27	-	V/°(
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	250 μΑ	1.0	-	2.0	V
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 10 '	V	-	-	± 100	nA
Zero Gate Voltage Drain Current		$V_{DS} = 200 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			-	-	25	<u> </u>
	IDSS	V _{DS} = 160 V	', V _{GS} = 0 V	, T _J = 160 °C	-	-	250	μA
		V _{GS} = 5.0 V	I _D	= 5.9 A ^b	-	-	0.18	Ω
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 4.0 V	I _D	= 5.0 A ^b	-	-	0.27	
Forward Transconductance	g _{fs}	V _{DS} =	= 50 V, I _D =	10 A ^b	16	-	-	S
Dynamic					•	•		1
Input Capacitance	C _{iss}		<u> </u>		-	1800	-	
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1.0 MHz, see fig. 5		-	400	-	pF	
Reverse Transfer Capacitance	C _{rss}			-	120	-		
Total Gate Charge	Qg				-	-	66	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V		A, V _{DS} = 160 V, fig. 6 and 13 ^b	-	-	9.0	nC
Gate-Drain Charge	Q _{gd}		See ní		-	-	38	
Turn-On Delay Time	t _{d(on)}		1		-	8.0	-	1
Rise Time	t _r	V _{DD} = 100 V, I _D = 17 A,			-	83	-	ns
Turn-Off Delay Time	t _{d(off)}	- R _G =	R _G = 4.6 Ω, R _D = 5.7 Ω, see fig. 10 ^b		-	44	-	
Fall Time	t _f		5		-	52	-	
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-		
Internal Source Inductance	L _S			-	7.5	-	nH	
Drain-Source Body Diode Characteristic	s				1	1	1	
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	9.9	- A	
Pulsed Diode Forward Currenta	I _{SM}			-	-	40		
Body Diode Voltage	V_{SD}	$T_J = 25 \ ^\circ C, \ I_S = 9.9 \ A, \ V_{GS} = 0 \ V^b$		-	-	2.0	V	
Body Diode Reverse Recovery Time	t _{rr}	$T_{J} = 25 \text{ °C}, I_{F} = 17 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}^{b}$		-	310	470	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			-	3.2	4.8	μ	
Forward Turn-On Time	t _{on}	Intrinsic tu	ırn-on time i	s negligible (turn	-on is don	ninated by	/ L _S and I	_D)

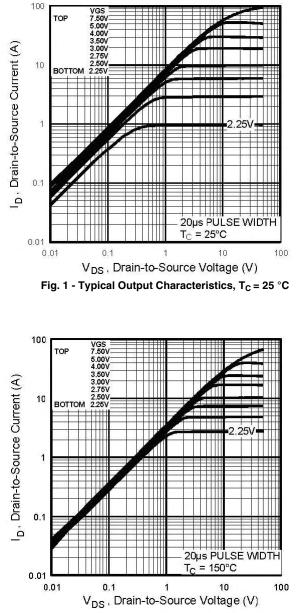
Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 $\mu s;$ duty cycle \leq 2 %.

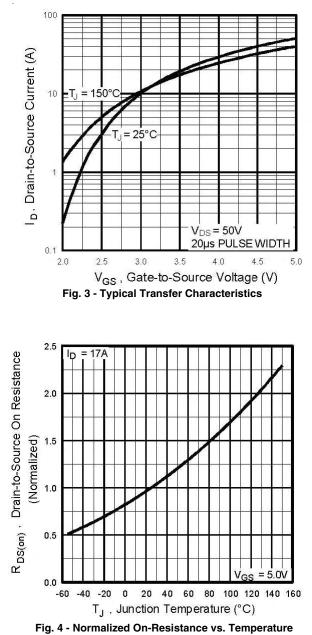


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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

Fig. 2 - Typical Output Characteristics, T_C = 150 $^\circ C$



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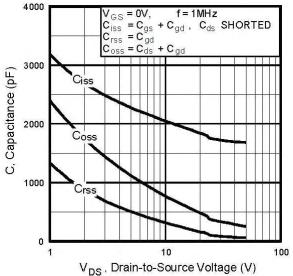
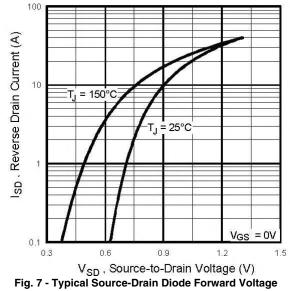
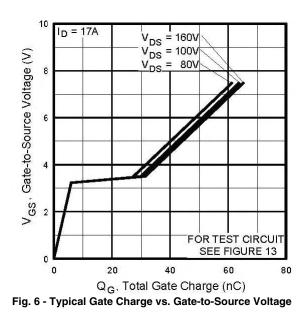
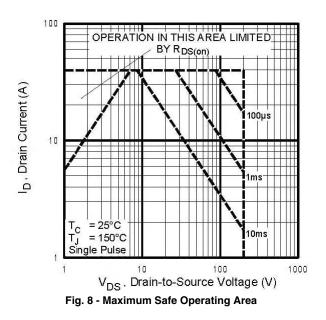
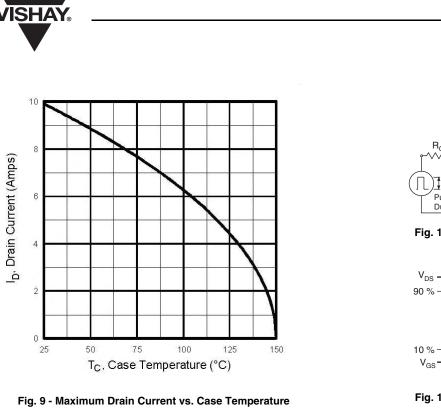


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage









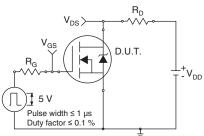


Fig. 10a - Switching Time Test Circuit

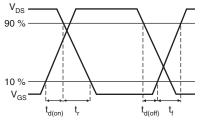


Fig. 10b - Switching Time Waveforms

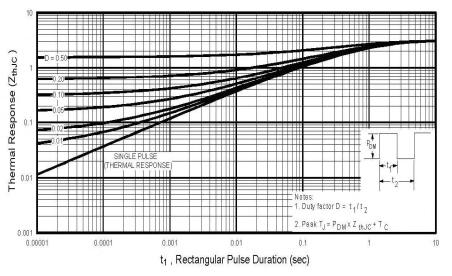
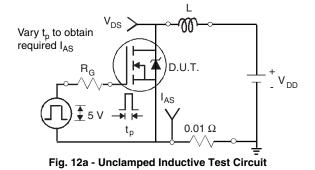


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



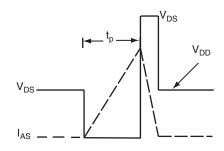


Fig. 12b - Unclamped Inductive Waveforms

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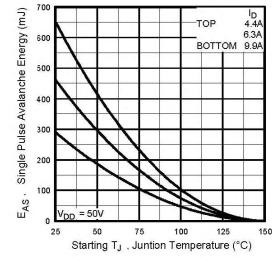


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

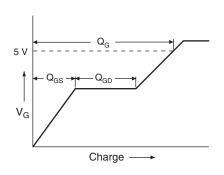


Fig. 13a - Basic Gate Charge Waveform

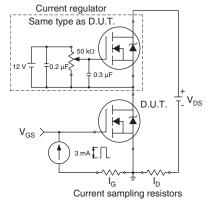
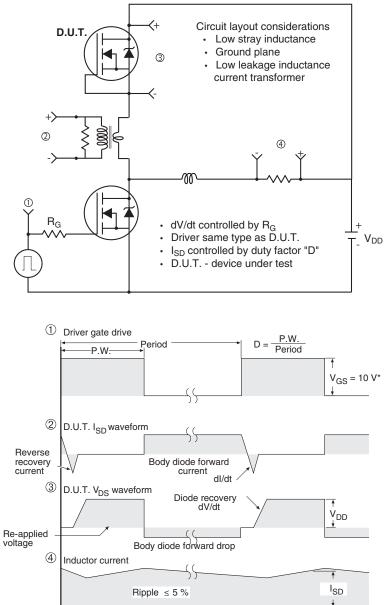


Fig. 13b - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit

* V_{GS} = 5 V for logic level devices and 3 V drive devices

Fig. 14 - For N-Channel

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